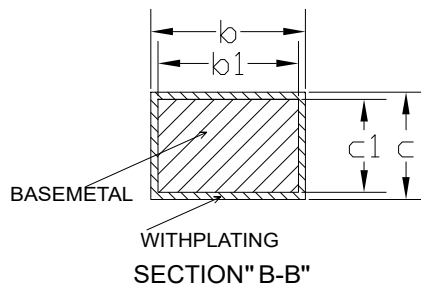
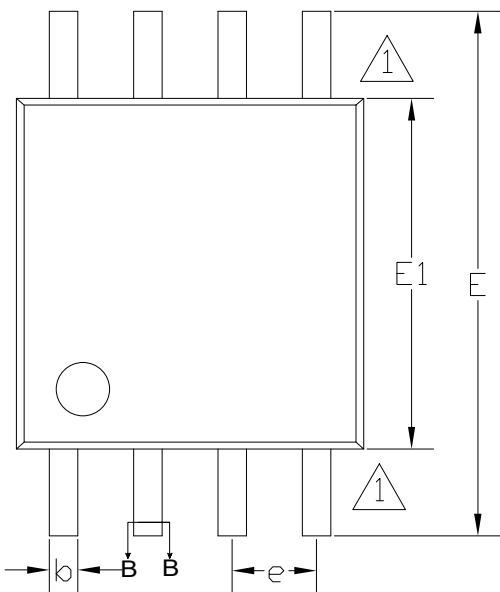
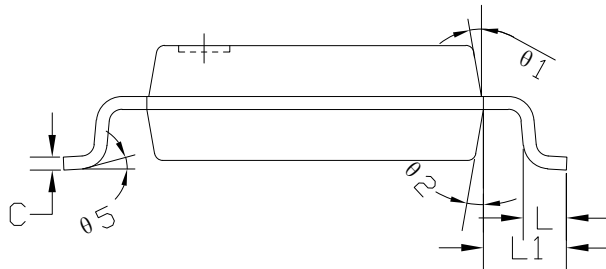
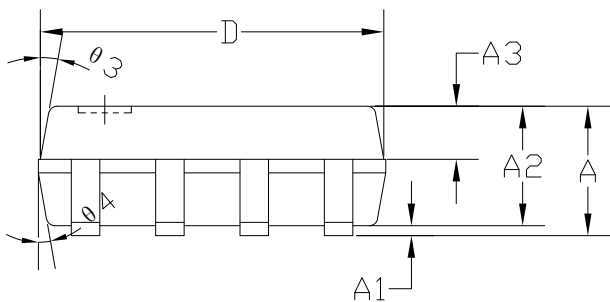




MARK	REVISION RECORD	VERSION	REVISERE
△1	修改管脚	C	
△2	更正引线框架厚度为0.203mm	D	



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	--	--	1.95
A1	0.10	0.15	0.18
A2	1.75	1.80	1.90
A3	0.78	0.80	0.82
b	0.33	--	0.47
b1	0.32	0.41	0.44
c	0.20	--	0.24
c1	0.19	0.20	0.21
D	5.07	5.17	5.27
E	7.70	7.90	8.10
E1	5.17	5.22	5.27
e	1.27(BSC)		
L	0.60	0.65	0.70
L1	1.31(BSC)		
θ1	8°	~	12°
θ2	8°	~	12°
θ3	8°	~	12°
θ4	8°	~	12°
θ5	0°	~	6°

技术说明:

- LEADFRAME MATERIAL: COPPER;
引线框架材料: 铜;
- LEADFRAME THICKNESS: 0.203mm;
引线框架厚度: 0.203mm; △2
- BOTH PACKAGE LENGTH AND WIDTH DO NOT INCLUDE MOLD FLASH;
塑封体长度及宽度尺寸不包括塑封溢胶;
- REFERENCE: JEDEC MS-013, MS-012. 参考标准: JEDEC MS-013, MS-012.

THIRD ANGLE PROJECTION		SCALE	UNIT	mm	TITLE
TOLERANCE		DATE	2024-09-03		SOP8L(W)产品成型图
		DESIGNER	CHECKER	APPROVER	DWG.NO. MT-PD-036
		曾怡			VERSION D 第1页, 共1页
		2024-09-03			